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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Grant Kenji Larsen

Serial No:

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Confirmation No:

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For:

SURFACE STRUCTURE AND METHOD OF MAKING, AND

ELECTORSTATIC WAFER CLAMP INCORPORATING

SURFACE STRUCUTRE

Examiner:

Stephen W. Jackson

Art Unit:

2836

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

The undersigned hereby certifies that this document is being placed in the United States mail with first-class postage attached, addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on the day of June, 2003.

Cheryl Purcell

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

RESPONSE UNDER 37 CFR § 1.111

In response to the Office Action mailed January 10, 2003, the following response is submitted in connection with the above-identified application.

= 8/A f.BEU. 6:2603